



CALL FOR PAPERS

27th IEEE/ACIS International Conference on Software Engineering, Artificial Intelligence, Networking and Parallel/Distributed Computing

(IEEE/ACIS SNPD 2023)

4-6 December 2024, Taichung, Taiwan

<http://www.acisinternational.org/snpd2023/>

Sponsored by IEEE and ACIS, USA.

In Cooperation with National Chin-Yi

University of Technology, Taiwan



Important Dates

Workshop/Special session proposal:	16 June, 2024
Workshop/Special session acceptance notification:	30 June, 2024
Full/Poster Paper submission:	4 September, 2024
Acceptance notification:	18 September, 2024
Registration & camera-ready papers:	1 October, 2024
Conference Dates:	4-6 December, 2024

IEEE/ACIS SNPD 2024 Proceedings will be published by IEEE Conference Publishing Services and will be submitted to be indexed by EI, INSPEC, and DBLP

Conference officers will select outstanding papers for publication in the following journals (www.acisinternational.org):

- *International Journal of Networked and Distributed Computing (IJNDC), Paris, France*
- *International Journal of Software Innovation (IJSI), IGI Global, U.S.A.*
- *International Journal of Big Data Intelligence and Applications (IJBDIA), IGI Global, U.S.A.*
- *Studies in Computational Intelligence (SCI), Springer, Germany*

Best Paper Award and Best Student Paper Awards will be conferred at the conference (in order to qualify for the award, the paper must be presented at the conference.)

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Mei-Ling Shyu, University of Miami, USA. Email: shyu@miami.edu

Mei Wang, Xi'an University of Science and Technology, China. Email: wangm@xust.edu.cn

Narayan C. Debnath, Eastern International University, Vietnam. Email: narayan.debnath@eiu.edu.vn

Trung Pham, University of Talca, Chile. Email: pham.trung@sbcglobal.net

Vincent CS Lee, Monash University, Australia. Email: Vincent.CS.Lee@monash.edu

Ming-Yi Tsai, National Chin-Yi University of Technology, Taiwan. Email: mytsai@ncut.edu.tw

Sheng-Chih Yang, National Chin-Yi University of Technology, Taiwan. Email: scyang@ncut.edu.tw

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